
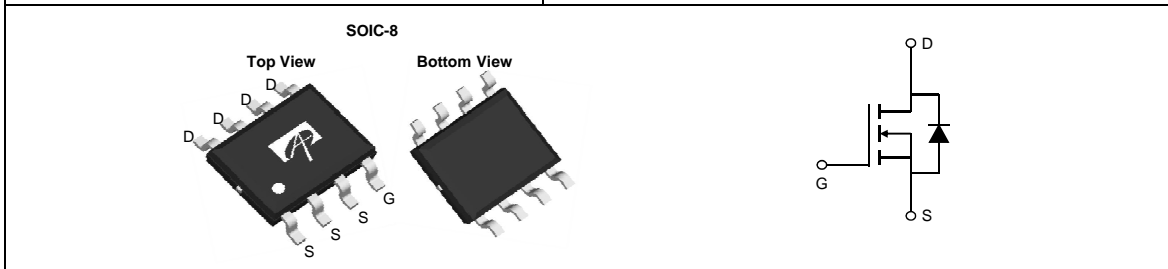




**THE DATASHEET OF
AO4292**



<p>General Description</p> <ul style="list-style-type: none"> Trench Power AlphaMOS (αMOS MV) technology Low $R_{DS(ON)}$ Low Gate Charge Optimized for fast-switching applications RoHS and Halogen-Free Compliant <p>Applications</p> <ul style="list-style-type: none"> Synchronous Rectification in DC/DC and AC/DC Converters Isolated DC/DC Converters in Telecom and Industrial 	<p>Product Summary</p> <table border="0"> <tr> <td>V_{DS}</td> <td>100V</td> </tr> <tr> <td>I_D (at $V_{GS}=10V$)</td> <td>8A</td> </tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=10V$)</td> <td>< 23mΩ</td> </tr> <tr> <td>$R_{DS(ON)}$ (at $V_{GS}=4.5V$)</td> <td>< 33mΩ</td> </tr> </table> <p>100% UIS Tested 100% Rg Tested</p> 	V_{DS}	100V	I_D (at $V_{GS}=10V$)	8A	$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 23mΩ	$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 33mΩ
V_{DS}	100V								
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$R_{DS(ON)}$ (at $V_{GS}=4.5V$)	< 33mΩ								



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AO4292	SO-8	Tape & Reel	3000

Absolute Maximum Ratings $T_A=25^{\circ}C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	8	A
		$T_A=25^{\circ}C$	
	$T_A=70^{\circ}C$	6.2	
Pulsed Drain Current ^C	I_{DM}	32	
Avalanche Current ^C	I_{AS}	15	A
Avalanche energy	E_{AS}	11	mJ
V_{DS} Spike	V_{SPIKE}	120	V
Power Dissipation ^B	P_D	3.1	W
		$T_A=25^{\circ}C$	
	$T_A=70^{\circ}C$	2.0	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	31	40	°C/W
		$t \leq 10s$		
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JL}$	59	75	°C/W
		Steady-State		
Maximum Junction-to-Lead	$R_{\theta JL}$	16	24	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	100			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =100V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±20V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.6	2.15	2.7	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =8A T _J =125°C		18 32.5	23 42	mΩ
		V _{GS} =4.5V, I _D =6A		24	33	
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =8A		30		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V		0.72	1	V
I _S	Maximum Body-Diode Continuous Current				4	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =50V, f=1MHz		1190		pF
C _{oss}	Output Capacitance			95		pF
C _{riss}	Reverse Transfer Capacitance			7		pF
R _g	Gate resistance	f=1MHz	0.5	1.1	1.7	Ω
SWITCHING PARAMETERS						
Q _{g(10V)}	Total Gate Charge	V _{GS} =10V, V _{DS} =50V, I _D =8A		16.5	25	nC
Q _{g(4.5V)}	Total Gate Charge			7	12	nC
Q _{gs}	Gate Source Charge			4.5		nC
Q _{gd}	Gate Drain Charge			2.5		nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =50V, R _L =6.25Ω, R _{GEN} =3Ω		7		ns
t _r	Turn-On Rise Time			3		ns
t _{D(off)}	Turn-Off DelayTime			20		ns
t _f	Turn-Off Fall Time			3		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =8A, dI/dt=500A/μs		20		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =8A, dI/dt=500A/μs		90		nC

A. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using ≤ 10s junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150° C. Ratings are based on low frequency and duty cycles to keep initial T_J=25° C.

D. The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of T_{J(MAX)}=150° C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

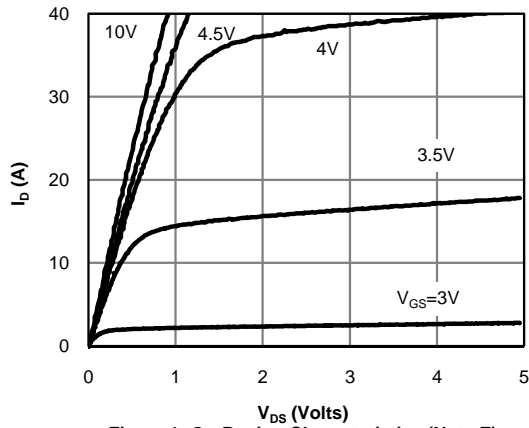


Figure 1: On-Region Characteristics (Note E)

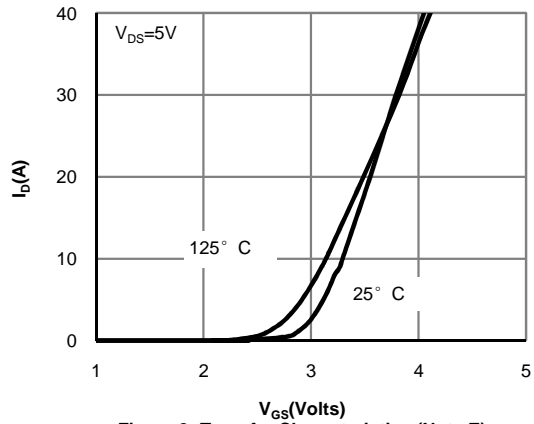


Figure 2: Transfer Characteristics (Note E)

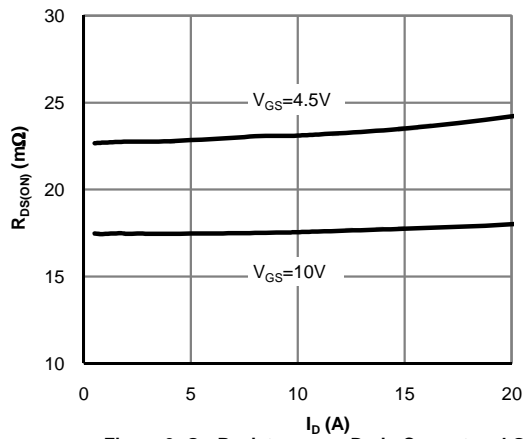


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

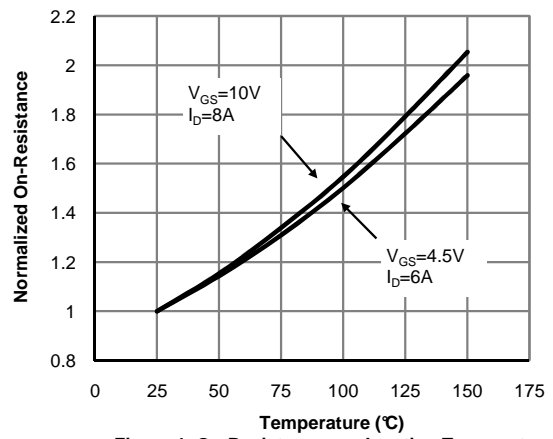


Figure 4: On-Resistance vs. Junction Temperature (Note E)

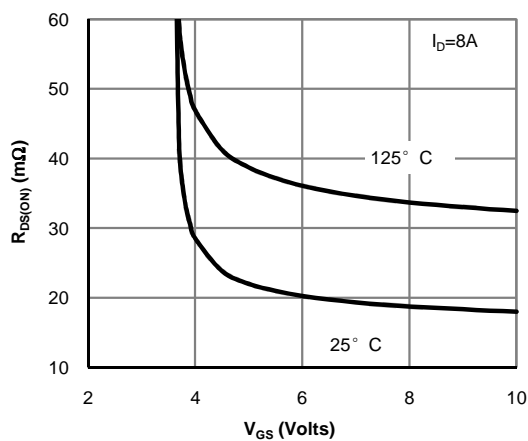


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

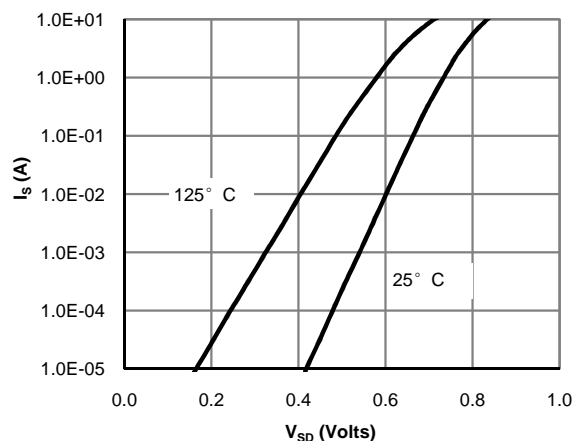
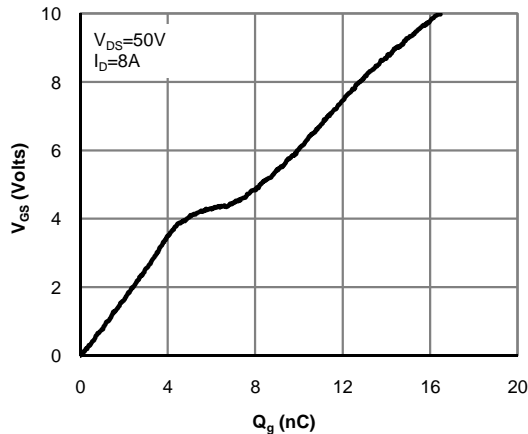
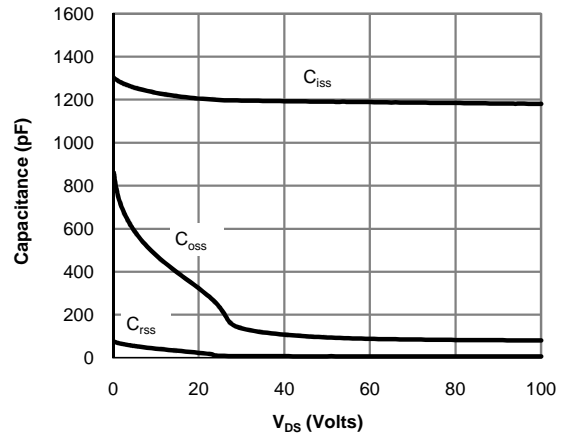
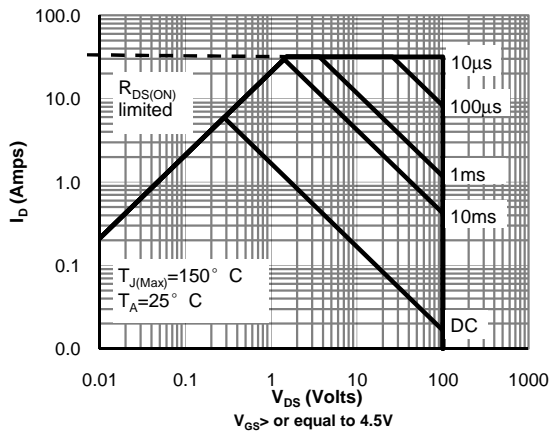
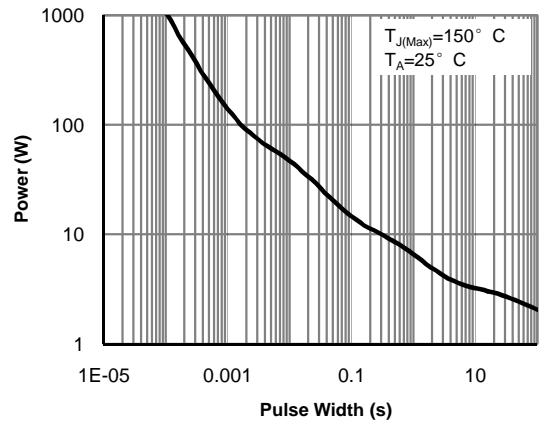
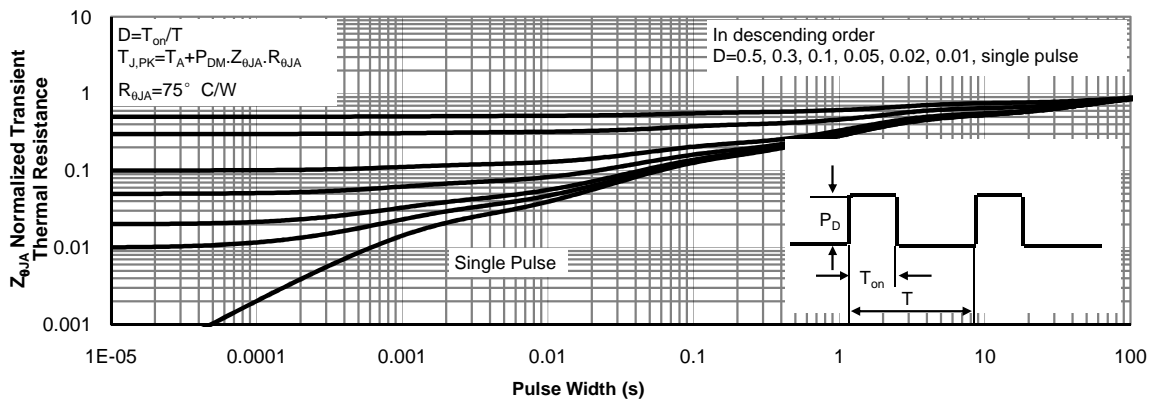
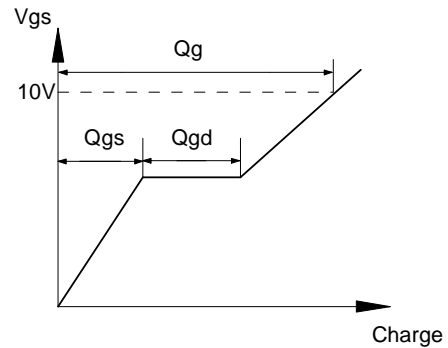
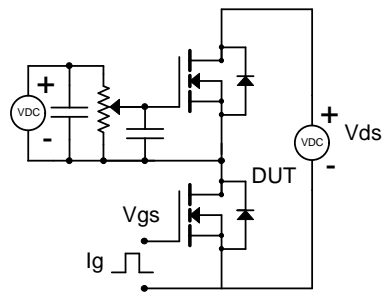


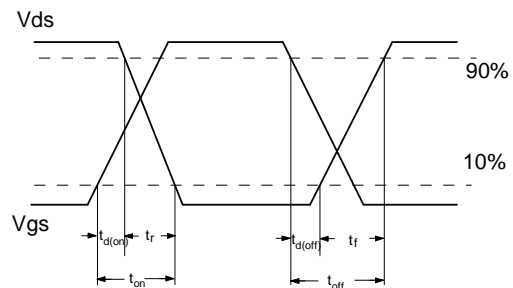
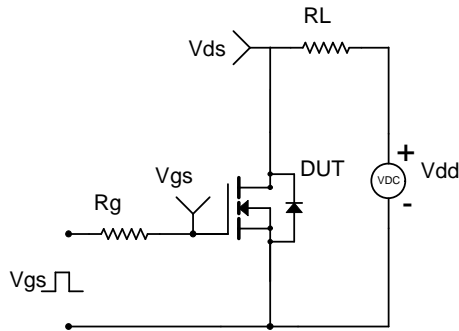
Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

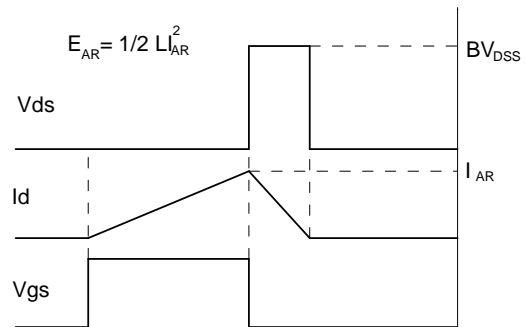
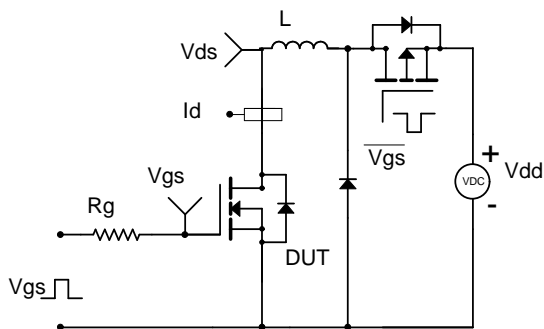
Gate Charge Test Circuit & Waveform



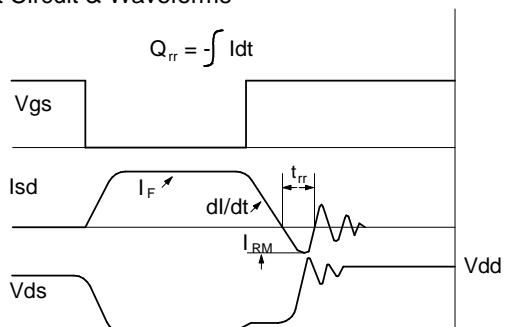
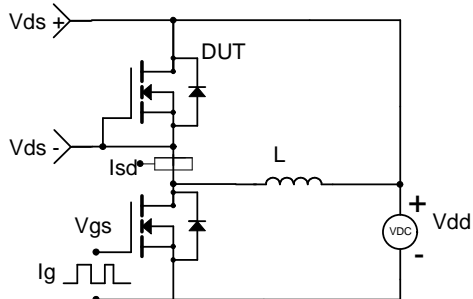
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms



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